IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re appli	cation of:	Art Unit: Not assigned
YAEGASH	II et al.	Examiner: Not assigned
Serial No:	Not assigned (parent 10/429,460)	
Filed:	January 29, 2004	•
For:	NON-VOLATILE SEMICONDUCTOR	

NON-VOLATILE SEMICONDUCTOR MEMORY DEVICE AND ITS MANUFACTURING METHOD

TRANSMITTAL OF INFORMATION DISCLOSURE STATEMENT

DIC	OLUL	JOILE STATEMENT
P.O.	Box 1	ner for Patents 450 ., VA 22313-1450
Dea	r Sirs:	
1. [mo apj int me cor	e information disclosure statement submitted herewith is being filed within three onths of the filing date of the application other than a continued prosecution plication, or within three months of the date of entry into the national stage of an ernational application, or before the mailing date of a first Office Action on the crits, or before the mailing of a first Office action after the filing of a request for a national examination under §1.114, whichever event occurs last. 37 C.F.R. 97(b).
2. [per §1. pro	e information disclosure statement transmitted herewith is being filed after the riod specified in §1.97(b), but before the mailing date of a final action under 113, or a notice of allowance under §1.311, or an action that otherwise closes osecution in the application, whichever occurs first. A statement specified in 97(e) or a fee set forth in §1.17(p) is included. 37 C.F.R. §1.97(c).
		§1.97(e) STATEMENT
	I, t	he person signing below, state:
		that each item of information contained in the information disclosure statement was first cited in the attached communication from a foreign patent office in a counterpart foreign application and that the communication is dated not more than three months prior to the filing of the statement. 37 C.F.R. §1.97(e)(1).
		OR
		that no item of information contained in the information disclosure statement was cited in a communication from a foreign patent office in a counterpart foreign application, and, to the knowledge of the person signing the certification

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after making reasonable inquiry, no item of information contained in the information disclosure statement was known to any individual designated in §1.56(c) more than three months prior to the filing of the statement. 37 C.F.R. §1.97(e)(2).

OR FEE Attached is a fee set forth in 37 C.F.R. §1.17(p) for submission of an information disclosure statement under §1.97(c). (\$180.00). [OR:] Please charge the fee set forth in 37 C.F.R. §1.17(p) for submission of an information disclosure statement under §1.97(c) (\$180.00) to Deposit Account No. 50-1314. A copy of this petition is enclosed. The information disclosure statement transmitted herewith is being filed after the period specified in §1.97(c), but before, or simultaneously with the payment of the issue fee. A statement specified in §1.97(e) and a fee set forth in §1.17(p) are included. 37 C.F.R. §1.97(d). §1.97(e) STATEMENT I, the person signing below, state: that each item of information contained in the information disclosure statement was first cited in the attached communication from a foreign patent office in a counterpart foreign application and that the communication is dated not more than three months prior to the filing of the statement. 37 C.F.R. §1.97(e)(1). OR that no item of information contained in the information disclosure statement

was cited in a communication from a foreign patent office in a counterpart foreign application, and, to the knowledge of the person signing the certification after making reasonable inquiry, no item of information contained in the information disclosure statement was known to any individual designated in §1.56(c) more than three months prior to the filing of the statement. 37 C.F.R. §1.97(e)(2).

AND FEE

- Attached is a fee set forth in 37 C.F.R. §1.17(p) for submission of an information disclosure statement under §1.97(d). (\$180.00).
- 4. If it should be determined that for any reason either an insufficient fee or an excessive has been paid, please charge any insufficiency or credit any overpayment necessary to ensure consideration of the information disclosure statement for the above-identified application to Deposit Account No. 50-1314. A copy of this petition is enclosed.

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5.	\boxtimes	C.F.R. § 1.98(d), copies of the listed in	enclosed Form PTO-1449. Pursuant to 37 reference(s) are not provided since they were all No10/138,849, the benefit of the filing date U.S.C. § 120.		
	NON-ENGLISH LANGUAGE REFERENCES				
	Enclosed is a search report for a counterpart application. The search report Examiner has provided comments on the relevancy of any non-English language references cited in the search report.				
		The specification incorporates comments on the relevancy of Non-English language references.			
		Set forth below are comments provide relevancy of non-English language r	ed by the applicant's home country counsel on the references:		
			Desmostfully submitted		
		•	Respectfully submitted, HOGAN & HARTSON L.L.P.		
			MOGAN CHARTSON E.E.T.		
Da	ate:	January 29, 2004	By: Anthony J. Orler		
Bi	ltmo	ore Tower	Registration No. 41,232		
		outh Grand Avenue, Suite 1900	Attorney for Applicant(s)		
		ngeles, CA 90071	** ``'		
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Facsimile:

(213) 337-6701

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FORM PTO-1449

INFORMATION DISCLOSURE CITATION IN AN APPLICATION

(Use several sheets if necessary)

Docket Number (Optional) Application Number
81790.0311 Not assigned

Applicant

YAEGASHI et al.

Filing Date January 29, 2004 Group Art Unit
Not assigned

		U.S. PATEN	T DOCUMENTS				
EXAMINER INITIAL	DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DA APPROPR	
	5,989,957	11-1999	Ngo et al.	438	257		•
	5,841,174	11-1998	Arai	257	392		
	5,852,311	12-1998	Kwon et al.	257	315		
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	5,824,583	10-1998	Asano et al.	438	258		
	FO FO	REIGN PAT	 TENT DOCUMENT	<u> </u> 'S			
	DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	Transl	ation
	62-045165	02-1987	Japan				
	08-23041	01/23/96	Japan				
	05-190811	07/30/93	Japan				
	05-183134	07-1993	Japan	438	396		
	02-246376	10-1990	Japan	. 257	320		
	62-23149	7/24/85	Japan		27/10		
	62-76668	9/30/85	Japan		27/10		
	7-297304	3/24/95	Japan		21/8247		
	OTHER DOCUMEN	TS (Including)	Author, Title, Date, Pert	inent Pages	s, Etc.)		
	HANNON, et al., "0.25 μm Merged B Digest of Technical Papers pages, 6		SOI Logic Using Patterne	ed SOI", 200	0 Symposium or	n VLSI Tech	nology
,	SCHEUERLEIN, et al., "A 10ns Read Switch in each Cell", ISSCC 2000/Se						
	YAMADA, et al., "An Embedded DRAM Technology on SOI/Bulk Hybrid Substrate Formed with SEG Process for High-End SOC Application", 2002 Symposium On VLSI Technology Digest of Technical Papers, pages 112 – 113						
	HANNON, et al., "0.25 μm Merged B Digest of Technical Papers pages, 6		SOI Logic Using Patterne	ed SOI", 200	0 Symposium o	n VLSI Tech	nology
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EXAMINER	DATE CONSIDERED

EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP § 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to the applicant.

Wolf, et al. "Silicon Processing for the VLSI Era," 1986, Lattice Press, Vol. 1, pages 384-388